

# 2STC4467

## High power NPN epitaxial planar bipolar transistor

### Features

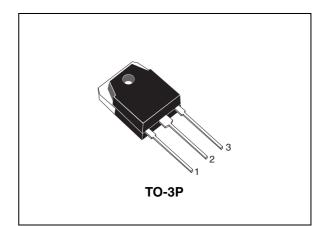
- High breakdown voltage V<sub>CEO</sub> = 120 V
- Complementary to 2STA1694
- Fast-switching speed
- Typical f<sub>t</sub> = 20 MHz
- Fully characterized at 125 °C

### **Applications**

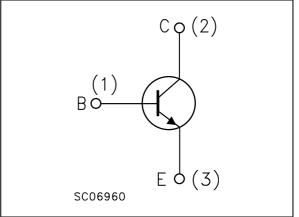
Audio power amplifier

### Description

The device is a NPN transistor manufactured using new BiT-LA (Bipolar transistor for linear amplifier) technology. The resulting transistor shows good gain linearity behaviour.



#### Figure 1. Internal schematic diagram



#### Table 1. Device summary

Order code	Marking	Package	Packaging
2STC4467	2STC4467	TO-3P	Tube

# 1 Electrical ratings

Symbol	Parameter	Value	Unit
V <sub>CBO</sub>	Collector-base voltage (I <sub>E</sub> = 0)	120	V
V <sub>CEO</sub>	Collector-emitter voltage $(I_B = 0)$	120	V
V <sub>EBO</sub>	Emitter-base voltage ( $I_C = 0$ )	6	V
۱ <sub>C</sub>	Collector current	8	А
I <sub>CM</sub>	Collector peak current (t <sub>P</sub> < 5 ms)	16	А
P <sub>TOT</sub>	Total dissipation at $T_c = 25 \text{ °C}$	80	W
T <sub>stg</sub>	Storage temperature	-65 to 150	°C
TJ	Max. operating junction temperature	150	°C

### Table 2. Absolute maximum rating

### Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	1.563	°C/W



## 2 Electrical characteristics

(T<sub>case</sub> = 25 °C; unless otherwise specified)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>CBO</sub>	Collector cut-off current $(I_E = 0)$	V <sub>CB</sub> = 120 V				10	μA
I <sub>EBO</sub>	Emitter cut-off current $(I_{\rm C}=0)$	V <sub>EB</sub> = 6 V				10	μA
V <sub>(BR)CEO</sub> <sup>(1)</sup>	Collector-emitter breakdown voltage (I <sub>B</sub> = 0)	l <sub>C</sub> = 50 mA		120			V
	Collector-base breakdown voltage (I <sub>E</sub> = 0)	I <sub>C</sub> = 100 μA		120			V
V <sub>(BR)EBO</sub> <sup>(1)</sup>	Emitter-base breakdown voltage $(I_{\rm C}=0)$	I <sub>E</sub> = 1 mA		6			V
V <sub>CE(sat)</sub> <sup>(1)</sup>	Collector-emitter saturation voltage	I <sub>C</sub> = 3 A	I <sub>B</sub> = 300 mA			1.5	V
h <sub>FE</sub>	DC current gain	I <sub>C</sub> = 3 A	$V_{CE} = 4 V$	70		140	
f <sub>T</sub>	Transition frequency	I <sub>C</sub> = 0.5 A	V <sub>CE</sub> = 12 V		20		MHz

#### Table 4. Electrical characteristics

1. Pulsed duration = 300  $\mu s,$  duty cycle  $~\leq 1.5\%$ 

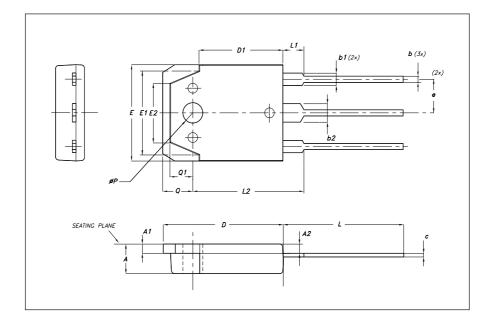


## 3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



	TO-3P Mechanical data			
DIM.	mm.			
Diwi.	MIN.	ТҮР	MAX.	
A	4.6		5	
A1	1.45	1.50	1.65	
A2	1.20	1.40	1.60	
b	0.80	1	1.20	
b1	1.80		2.20	
b2	2.80		3.20	
с	0.55	0.60	0.75	
D	19.70	19.90	20.10	
D1		13.90		
E	15.40		15.80	
E1		13.60		
E2		9.60		
e	5.15	5.45	5.75	
L	19.50	20	20.50	
L1		3.50		
L2	18.20	18.40	18.60	
P	3.10		3.30	
Q		5		
Q1		3.80		





## 4 Revision history

 Table 5.
 Document revision history

Date	Revision	Changes	
22-Nov-2007	1	Initial release	
30-Apr-2008	2	Document status promoted from preliminary data to datasheet.	



57

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